

AMENDMENTS TO THE CLAIMS

The following listing of claims replaces all prior versions of claims in the application.

1. (Original): A method of manufacturing a flexible laminate substrate including a metal foil bonded onto at least one surface of a heat-resistant adhesive film, the method comprising the steps of:

thermally laminating the heat-resistant adhesive film and the metal foil between one or more pairs of metal rolls via a protective film to fabricate a laminate in which the heat-resistant adhesive film, the metal foil, and the protective film are bonded together; and

delaminating the protective film,

greater tension being applied to the laminate during the delamination of the protective film than after the passage between the metal rolls.

2. (Original): The method of claim 1, wherein the tension on the laminate during the delamination of the protective film is from 50 N/m to 500 N/m inclusive.

3. (Currently amended): The method of ~~either one of claims 1 and 2~~ claim 1, wherein the tension on the laminate after the passage between the metal rolls is from 10 N/m to 200 N/m inclusive.

4. (Currently amended): The method of ~~any one of claims 1 to 3~~ claim 1, wherein the tension after the passage between the metal rolls and before delamination is regulated using nip rolls.

5. (Currently amended): The method of ~~any one of claims 1 to 4~~ claim 1, wherein during the delamination of the protective film, the laminate has a temperature less than or equal to a glass transition temperature of an adhesive layer in the heat-resistant adhesive film.

6. (Currently amended): The method of ~~any one of claims 1 to 5~~ claim 1, wherein the protective film is non-thermoplastic.